Triple inverting Schmitt trigger Rev. 5 — 9 December 2013

Product data sheet

#### 1. **General description**

The 74HC3G14; 74HCT3G14 is a triple inverter with Schmitt-trigger inputs. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>. Schmitt trigger inputs transform slowly changing input signals into sharply defined jitter-free output signals.

#### **Features and benefits** 2.

- Wide supply voltage range from 2.0 V to 6.0 V
- Complies with JEDEC standard no. 7A
- Input levels:
  - For 74HC3G14: CMOS level
  - For 74HCT3G14: TTL level
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- Unlimited input rise and fall times
- Multiple package options
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

#### Applications 3.

- Wave and pulse shaper for highly noisy environments
- Astable multivibrators
- Monostable multivibrators



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### 4. Ordering information

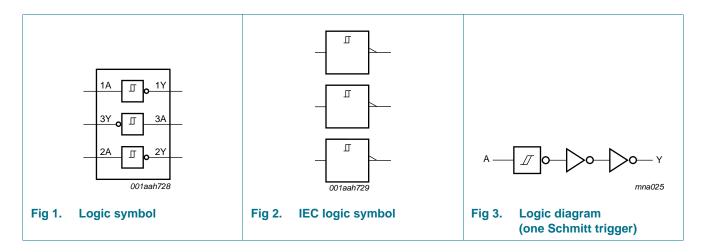
Type number	Package								
	Temperature range	Name	Description	Version					
74HC3G14DP	–40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads;	SOT505-2					
74HCT3G14DP			body width 3 mm; lead length 0.5 mm						
74HC3G14DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads;	SOT765-1					
74HCT3G14DC			body width 2.3 mm						
74HC3G14GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads;	SOT996-2					
74HCT3G14GD			8 terminals; body $3 \times 2 \times 0.5$ mm						

### 5. Marking

Table 2. Marking	
Type number	Marking code <sup>[1]</sup>
74HC3G14DP	H14
74HCT3G14DP	T14
74HC3G14DC	H14
74HCT3G14DC	T14
74HC3G14GD	H14
74HCT3G14GD	T14

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

## 6. Functional diagram

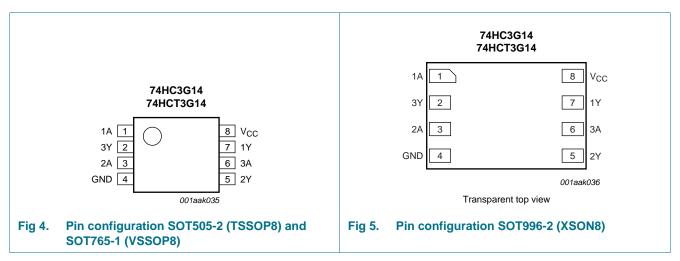


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### 7. Pinning information

### 7.1 Pinning



#### 7.2 Pin description

Table 3. Pin de	scription	
Symbol	Pin	Description
1A, 2A, 3A	1, 3, 6	data input
GND	4	ground (0 V)
1Y, 2Y, 3Y	7, 5, 2	data output
V <sub>CC</sub>	8	supply voltage

## 8. Functional description

#### Table 4.Function table<sup>[1]</sup>

Input	Output
nA	nY
L	Н
Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

### 9. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	$V_{\rm O}$ = –0.5 V to V_{\rm CC} + 0.5 V	<u>[1]</u> -	±25	mA
I <sub>CC</sub>	supply current		<u>[1]</u> _	+50	mA
I <sub>GND</sub>	ground current		<u>[1]</u> –50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation		[2] _	300	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP8 package: above 55 °C the value of P<sub>tot</sub> derates linearly with 2.5 mW/K. For VSSOP8 package: above 110 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K. For XSON8 package: above 118 °C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

## 10. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	DI Parameter Conditions		74HC3G14			74HCT3G14			Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	$V_{CC}$	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C

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### 11. Static characteristics

#### **Static characteristics** Table 7.

Voltages are referenced to GND (ground = 0 V). All typical values are measured at  $T_{amb}$  = 25 °C.

Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC3G	14									
V <sub>OH</sub>	HIGH-level	$V_I = V_{T+} \text{ or } V_{T-}$								
	output voltage	$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 4.5 V	4.18	4.32	-	4.13	-	3.7	-	V
		$I_{O}$ = -5.2 mA; $V_{CC}$ = 6.0 V	5.68	5.81	-	5.63	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{T+} \text{ or } V_{T-}$								
	output voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
	$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V	
lı	input leakage current	$V_{\text{I}}$ = $V_{\text{CC}}$ or GND; $V_{\text{CC}}$ = 6.0 V	-	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>CC</sub>	supply current	per input pin; $V_{CC} = 6.0 V$ ; $V_I = V_{CC}$ or GND; $I_O = 0 A$ ;	-	-	1.0	-	10	-	20	μA
CI	input capacitance		-	2.0	-	-	-	-	-	pF
74HCT3	G14									
V <sub>он</sub>	HIGH-level	$V_I = V_{T+}$ or $V_{T-}$								
	output voltage	$I_0 = -20 \ \mu A; V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.18	4.32	-	4.13	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>CC</sub>	supply current	per input pin; $V_{CC} = 5.5 V$ ; $V_I = V_{CC}$ or GND; $I_O = 0 A$ ;	-	-	1.0	-	10	-	20	μA
Δl <sub>CC</sub>	additional supply current	per input; $V_{CC} = 4.5 V \text{ to } 5.5 V;$ $V_I = V_{CC} - 2.1 V; I_O = 0 A$	-	-	300	-	375	-	410	μΑ
Cı	input capacitance		-	2.0	-	-	-	-	-	pF

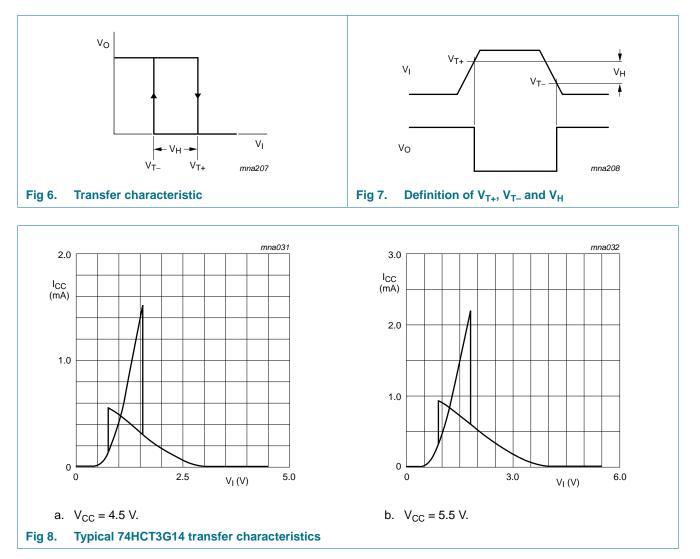
Triple inverting Schmitt trigger

Symbol	Parameter	Conditions		25 °C		-40	0 °C to +1	25 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
74HC3G	14								
V <sub>T+</sub>	positive-going	see Figure 6, Figure 7							
	threshold voltage	$V_{CC} = 2.0 V$	1.00	1.18	1.50	1.00	1.50	1.50	V
		$V_{CC} = 4.5 V$	2.30	2.60	3.15	2.30	3.15	3.15	V
		$V_{CC} = 6.0 V$	3.00	3.46	4.20	3.00	4.20	4.20	V
V <sub>T-</sub>	negative-going	see Figure 6, Figure 7							
threshold voltage	$V_{CC} = 2.0 V$	0.30	0.60	0.90	0.30	0.90	0.90	V	
		$V_{CC} = 4.5 V$	1.13	1.47	2.00	1.13	2.00	2.00	V
		$V_{CC} = 6.0 V$	1.50	2.06	2.60	1.50	2.60	2.60	V
V <sub>H</sub> hy	hysteresis voltage	(V <sub>T+</sub> – V <sub>T−</sub> ); see <u>Figure 6,</u> <u>Figure 7</u> and <u>Figure 9</u>							
		$V_{CC} = 2.0 V$	0.30	0.60	1.00	0.30	1.00	1.00	V
		$V_{CC} = 4.5 V$	0.60	1.13	1.40	0.60	1.40	1.40	V
		$V_{CC} = 6.0 V$	0.80	1.40	1.70	0.80	1.70	1.70	V
74HCT3	G14								
V <sub>T+</sub>	positive-going	see Figure 6, Figure 7							
	threshold voltage	$V_{CC} = 4.5 V$	1.20	1.58	1.90	1.20	1.90	1.90	V
		$V_{CC} = 5.5 V$	1.40	1.78	2.10	1.40	2.10	2.10	V
V <sub>T-</sub>	negative-going	see Figure 6, Figure 7							
	threshold voltage	$V_{CC} = 4.5 V$	0.50	0.87	1.20	0.50	1.20	1.20	V
		$V_{CC} = 5.5 V$	0.60	1.11	1.40	0.60	1.40	1.40	V
V <sub>H</sub>	hysteresis voltage	(V <sub>T+</sub> – V <sub>T−</sub> ); see <u>Figure 6,</u> <u>Figure 7</u> and <u>Figure 8</u>							
		$V_{CC} = 4.5 V$	0.40	0.71	-	0.40	-	-	V
		$V_{CC} = 5.5 V$	0.40	0.67	-	0.40	-	-	V

#### Table 8.Transfer characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 11.

Triple inverting Schmitt trigger



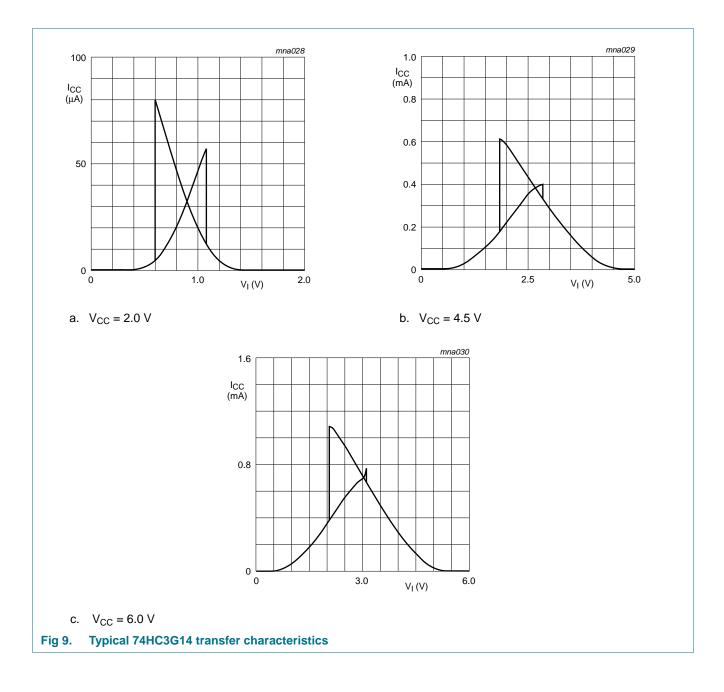
### **11.1 Waveforms transfer characteristics**

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#### **NXP Semiconductors**

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### **12. Dynamic characteristics**

#### Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 11</u>.

Symbol	Parameter	Conditions			25 °C		-4	0 °C to +1	25 °C	Unit
				Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	_
74HC3G1	4									
t <sub>pd</sub>	propagation delay	nA to nY; see Figure 10	<u>[1]</u>							
	$V_{CC} = 2.0 V$		-	53	125	-	155	190	ns	
	$V_{CC} = 4.5 V$		-	16	25	-	31	38	ns	
		$V_{CC} = 6.0 V$		-	13	21	-	26	32	ns
t <sub>t</sub> transition time	transition time	nY; see <u>Figure 10</u>	[2]							
		$V_{CC} = 2.0 V$		-	20	75	-	95	110	ns
		$V_{CC} = 4.5 V$		-	7	15	-	19	22	ns
		$V_{CC} = 6.0 V$		-	5	13	-	16	19	ns
C <sub>PD</sub>	power dissipation capacitance	$V_I = GND$ to $V_{CC}$	<u>[3]</u>	-	10	-	-	-	-	pF
74HCT36	614									
t <sub>pd</sub>	propagation delay	nA to nY; see <u>Figure 10</u>	<u>[1]</u>							
		$V_{CC} = 4.5 V$		-	21	32	-	40	48	ns
tt	transition time	nY; see <u>Figure 10</u>	[2]							
		$V_{CC} = 4.5 V$		-	6	15	-	19	22	ns
C <sub>PD</sub>	power dissipation capacitance	$V_{I}$ = GND to $V_{CC}$ – 1.5 V	<u>[3]</u>	-	10	-	-	-	-	pF

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ 

 $\label{eq:ttilde} [2] \quad t_t \text{ is the same as } t_{TLH} \text{ and } t_{THL}$ 

[3] C\_{PD} is used to determine the dynamic power dissipation (P\_D in  $\mu W).$ 

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

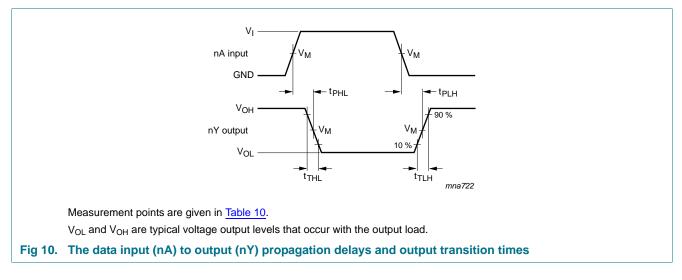
 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs.

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### 13. Waveforms



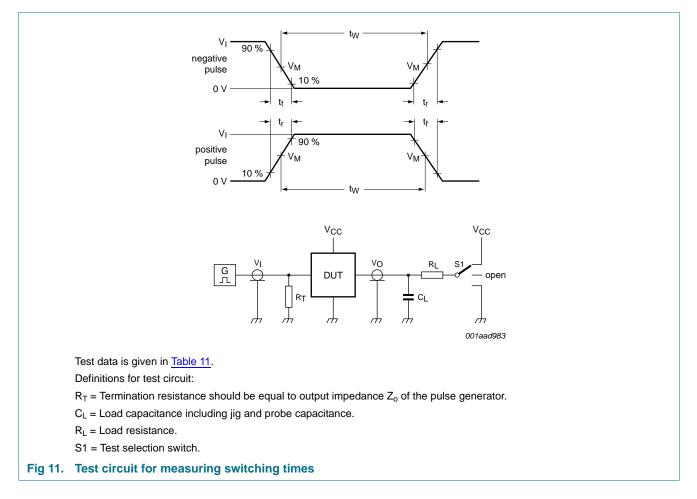
#### Table 10. Measurement points

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC3G14	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT3G14	1.3 V	1.3 V

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### Triple inverting Schmitt trigger



#### Table 11. Test data

Туре	Input		Load	S1 position	
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>
74HC3G14	GND to V <sub>CC</sub>	≤ 6 ns	50 pF	1 kΩ	open
74HCT3G14	GND to 3.0 V	≤ 6 ns	50 pF	1 kΩ	open

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### 14. Application information

The slow input rise and fall times cause additional power dissipation, which can be calculated using the following formula:

 $P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC} \text{ where:}$ 

 $P_{add}$  = additional power dissipation ( $\mu$ W);

 $f_i = input frequency (MHz);$ 

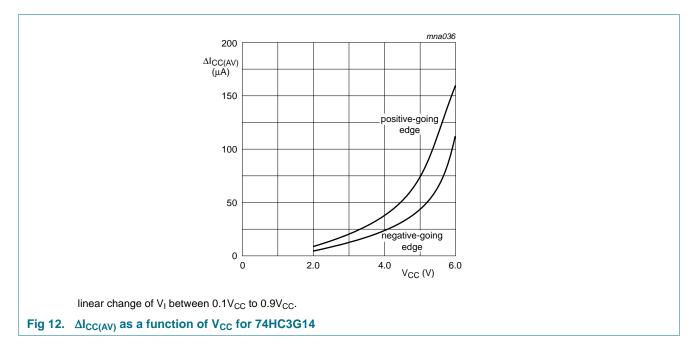
 $t_r$  = input rise time (ns); 10 % to 90 %;

 $t_f$  = input fall time (ns); 90 % to 10 %;

 $\Delta I_{CC(AV)}$  = average additional supply current (µA).

 $\Delta I_{CC(AV)}$  differs with positive or negative input transitions, as shown in Figure 12 and Figure 13.

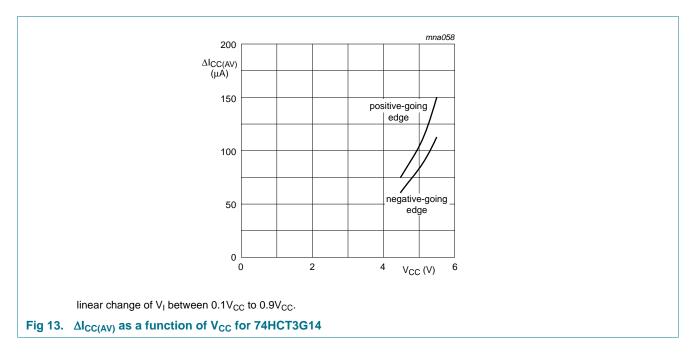
An example of a relaxation circuit using the 74HC3G14/74HCT3G14 is shown in Figure 14.

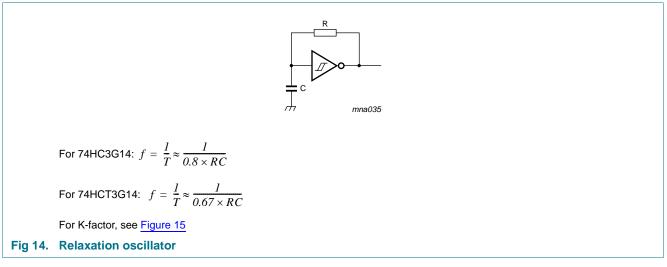


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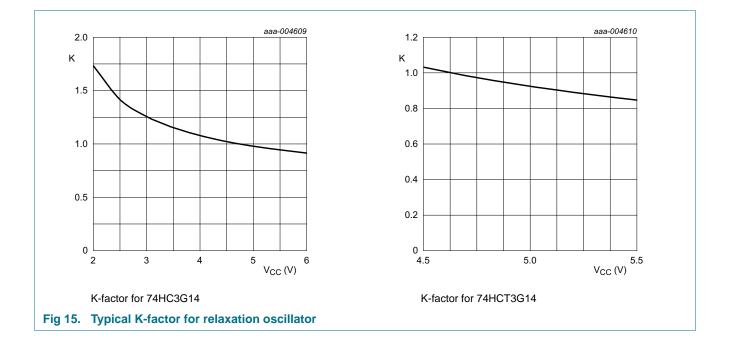




#### **NXP Semiconductors**

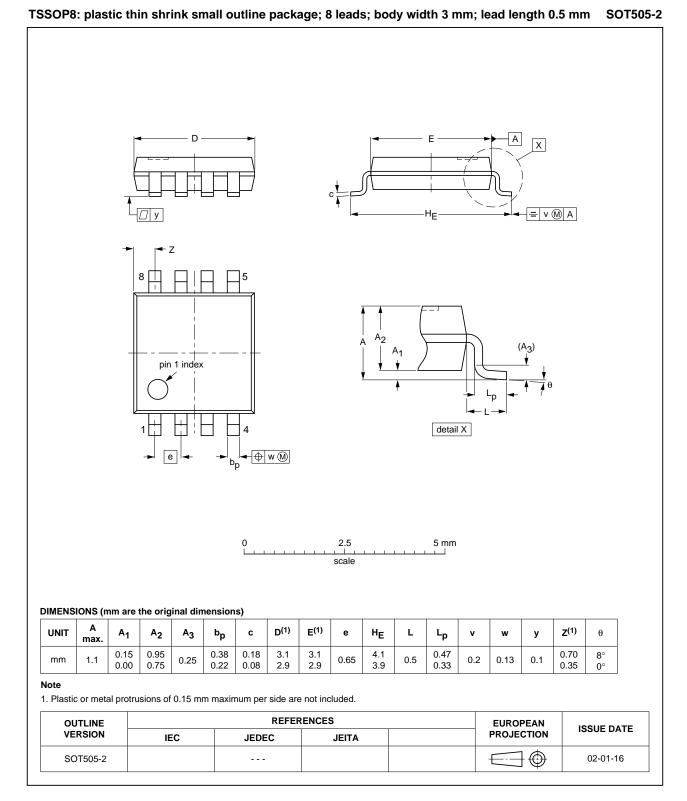
# 74HC3G14; 74HCT3G14

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### 15. Package outline



#### Fig 16. Package outline SOT505-2 (TSSOP8)

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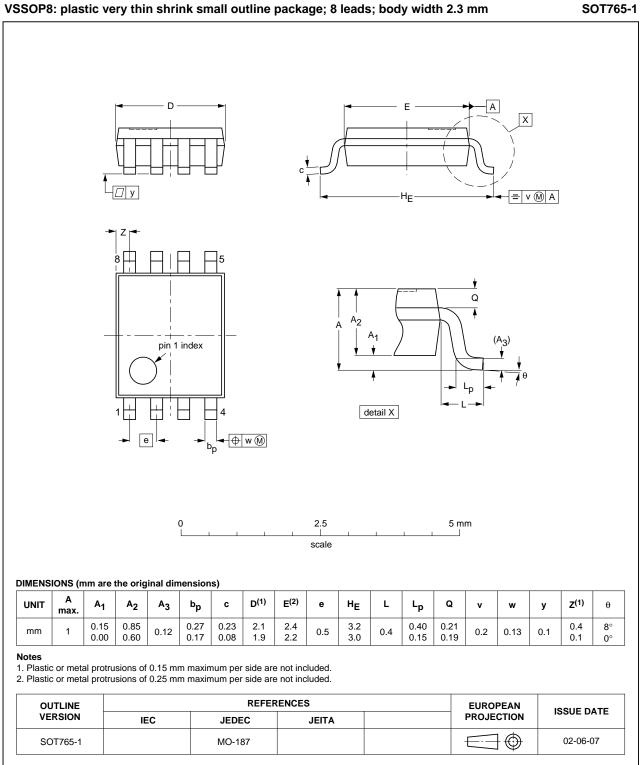
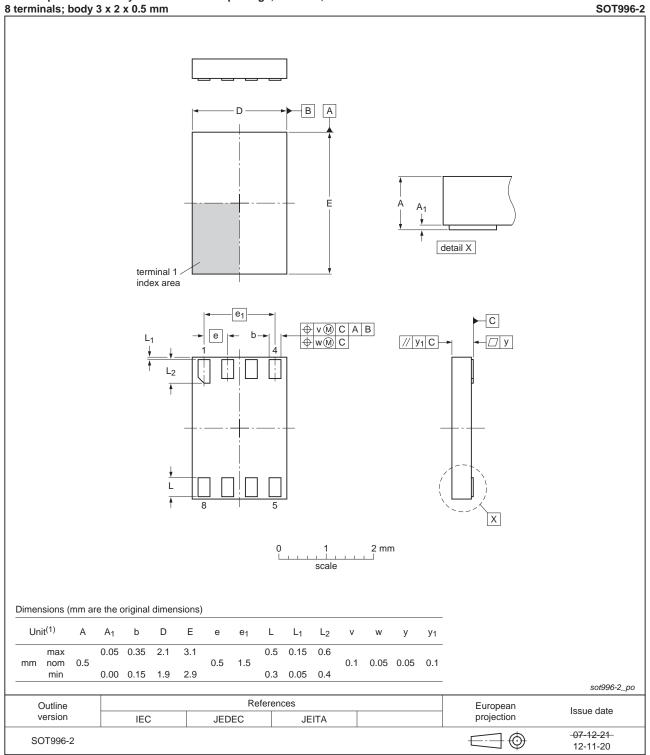


Fig 17. Package outline SOT765-1 (VSSOP8)

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**Triple inverting Schmitt trigger** 



XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 3 x 2 x 0.5 mm

Fig 18. Package outline SOT996-2 (XSON8)

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Triple inverting Schmitt trigger

## **16. Abbreviations**

Table 12.	Abbreviations
Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
-	

## **17. Revision history**

### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT3G14 v.5	20131209	Product data sheet	-	74HC_HCT3G14 v.4
Modifications:	• Figure 15 a	dded (typical K-factor for rela	axation oscillator).	
74HC_HCT3G14 v.4	20131003	Product data sheet	-	74HC_HCT3G14 v.3
Modifications:	<ul> <li>For type nu</li> </ul>	mbers 74HC3G14GD and 74	4HCT3G14GD XSON8	U has changed to XSON8.
74HC_HCT3G14 v.3	20090508	Product data sheet	-	74HC_HCT3G14 v.2
74HC_HCT3G14 v.2	20031104	Product specification	-	74HC_HCT3G14 v.1
74HC HCT3G14 v.1	20020723	Product specification	-	-

### **18. Legal information**

#### 18.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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